

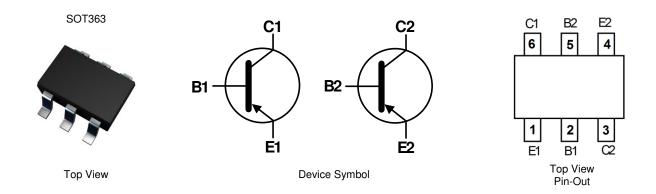
### **60V DUAL PNP SMALL SIGNAL TRANSISTOR IN SOT363**

### **Features**

- Ultra-Small Surface Mount Package
- Epitaxial Planar Die Construction
- Ideal for Low Power Amplification and Switching
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

### **Mechanical Data**

- Case: SOT363
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Finish. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.006 grams (Approximate)



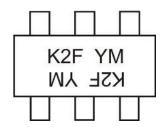
### Ordering Information (Notes 4 & 5)

Product	Status	Compliance	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
MMDT2907A-7-F	Active	AEC-Q101	K2F	7	8	3,000
MMDT2907AQ-7-F	Active	Automotive	K2F	7	8	3,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/product\_compliance\_definitions.html.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## **Marking Information**



K2F = Product Type Marking Code YM = Date Code Marking Y = Year (ex: D = 2016) M = Month (ex: 9 = September)

Date Code Kev

Year	2016	2017	2018	2019	2020	2021	2022	2023	2024	2025	2026	2027
Code	D	E	F	G	Н		J	K	L	М	N	0
14 11-	1	F. I.		A			11	A	0	0-1	NI	D
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



## Absolute Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	-60	V
Collector-Emitter Voltage	$V_{\sf CEO}$	-60	V
Emitter-Base Voltage	$V_{EBO}$	-5.0	V
Collector Current	lc	-600	mA

## Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

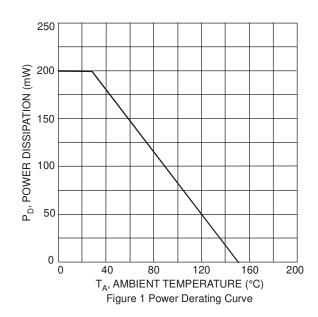
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	$P_D$	200	mW
Thermal Resistance, Junction to Ambient Air (Note 6)	$R_{ hetaJA}$	625	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

## ESD Ratings (Note 7)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

Notes:

## **Thermal Characteristics and Derating Information**



<sup>6.</sup> For the device mounted on minimum recommended pad layout FR-4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.

7. Refer to JEDEC specification JESD22-A114 and JESD22-A115.



# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS						
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	-60	1	_	V	$I_C = -10\mu A, I_B = 0$
Collector-Emitter Breakdown Voltage (Note 8)	BV <sub>CEO</sub>	-60	1		V	$I_C = -10 \text{mA}, I_B = 0$
Emitter-Base Breakdown Voltage	$BV_{EBO}$	-5		1	V	$I_E = -10\mu A, I_C = 0$
Collector Cutoff Current	1	1	1	-10	nA	$V_{CB} = -50V, I_{E} = 0$
Collector Outon Gurrent	Ісво	_	_	-10	μΑ	$V_{CB} = -50V, I_E = 0, T_A = +125^{\circ}C$
Collector Cutoff Current	I <sub>CEX</sub>	_	_	-50	nA	$V_{CE} = -30V$ , $V_{EB(OFF)} = -0.5V$
Base Cutoff Current	$I_{BL}$	_	_	-50	nA	$V_{CE} = -30V, V_{EB(OFF)} = -0.5V$
ON CHARACTERISTICS (Note 8)						
		75	_	_		$I_C = -100 \mu A$ , $V_{CE} = -10 V$
		100	_	_		$I_C = -1.0 \text{mA}, V_{CE} = -10 \text{V}$
DC Current Gain	h <sub>FE</sub>	100	_	_	_	$I_C = -10 \text{mA}, V_{CE} = -10 \text{V}$
		100	_	300		$I_C = -150 \text{mA}, V_{CE} = -10 \text{V}$
		50	_	_		$I_C = -500 \text{mA}, V_{CE} = -10 \text{V}$
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	_	_	-0.4	V	$I_C = -150 \text{mA}, I_B = -15 \text{mA}$
- Consense - Catalanan Fontage	V O⊏(Sat)			-1.6	•	$I_C = -500 \text{mA}, I_B = -50 \text{mA}$
Base-Emitter Saturation Voltage	V <sub>BE(sat)</sub>	_	_	-1.3	V	$I_C = -150 \text{mA}, I_B = -15 \text{mA}$
, and the second	• DL(Sat)			-2.6		$I_C = -500 \text{mA}, I_B = -50 \text{mA}$
SMALL SIGNAL CHARACTERISTICS	I _					T
Output Capacitance	Сово		_	8.0	pF	$V_{CB} = -10V, f = 1.0MHz, I_{E} = 0$
Input Capacitance	C <sub>IBO</sub>		_	30	pF	$V_{EB} = -2.0V, f = 1.0MHz, I_{C} = 0$
Current Gain Bandwidth Product	f⊤	200	_	_	MHz	$V_{CE} = -20V, I_{C} = -50mA,$ f = 100MHz
SWITCHING CHARACTERISTICS						
Turn-On Time	t <sub>on</sub>	1	1	45	ns	V 20V I 150A
Delay Time	t <sub>d</sub>	-	_	10	ns	$V_{CC} = -30V, I_{C} = -150mA,$ $I_{B1} = -15mA$
Rise Time	t <sub>r</sub>	_	_	40	ns	IB1 = - IOIIIA
Turn-Off Time	t <sub>off</sub>	_	_	100	ns	V 6V 1 150 A
Storage Time	ts	-	_	80	ns	$V_{CC} = -6V, I_{C} = -150mA,$
Fall Time	t <sub>f</sub>	_	_	30	ns	$I_{B1} = -I_{B2} = -15\text{mA}$

Note:

8. Short duration pulse test used to minimize self-heating effect.



## Typical Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

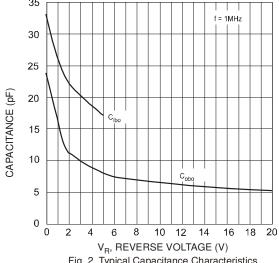


Fig. 2, Typical Capacitance Characteristics

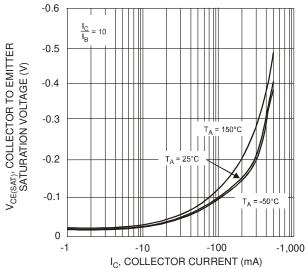


Fig. 4, Collector Emitter Saturation Voltage vs. Collector Current

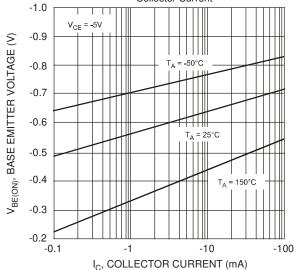


Fig. 6, Base Emitter Voltage vs. Collector Current

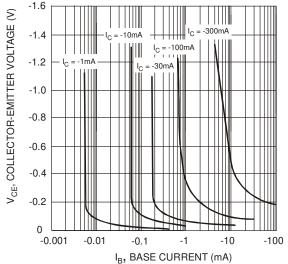


Fig. 3, Typical Collector Saturation Region

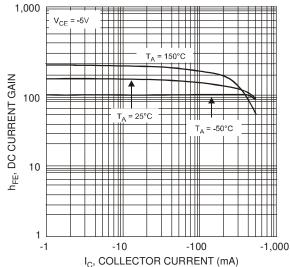


Fig. 5, DC Current Gain vs. Collector Current

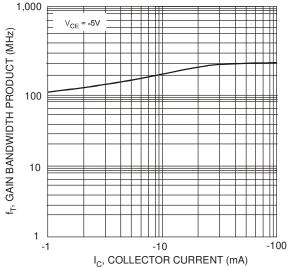


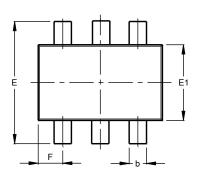
Fig. 7, Gain Bandwidth Product vs. Collector Current

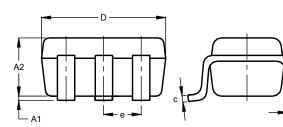


## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### **SOT363**



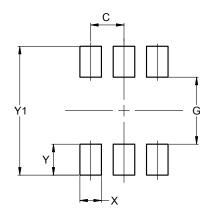


SOT363						
Dim	Min	Max	Тур			
A1	0.00	0.10	0.05			
A2	0.90	1.00	1.00			
b	0.10	0.30	0.25			
С	0.10	0.22	0.11			
D	1.80	2.20	2.15			
Е	2.00	2.20	2.10			
E1	1.15	1.35	1.30			
е	C	).650 E	SC			
F	0.40	0.45	0.425			
١	0.25	0.40	0.30			
а	0°	8°				
All	All Dimensions in mm					

# Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

### **SOT363**



Dimensions	Value			
Dilliensions	(in mm)			
С	0.650			
G	1.300			
X	0.420			
Υ	0.600			
Y1	2.500			



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